

Audio Codec Overview

Audio Portfolio

Texas Instruments' complete line of audio products feature over 2000 devices within our DAC, ADC, CODEC, AMP, Line driver, Interface, USB Audio, and other product families.

ADC		AMP		CODEC		DAC		Smart AMP	
HW / SW Controlled		Stereo/Mono Class AB & D w/Boost		Power and Performance Optimized		Current Output, Voltage Output, 2VRMS Output, Delta Sigma		Low and Mid Power Amplifiers with Smart Speaker Protection	
1.8-3.3-5V Power		Analog Input		Integrated Amplifiers		Integrated Amplifiers		Integrated IV Sense, Excursion and Temp sensing options	
Audio PLL		Low Power options w/ PurePath™		Integrated DSP		DSP integration			
Energy Sense									
#ADC	1-4	Inputs	1-6	#ADC/DAC	0-6 / 1-8	#DAC	1-8	Output	7.5 – 50W
SNR	92-123dB	Output Power	0.35-400W	ADC/DAC SNR	72-112dB	SNR	92-127dB	PSRR	75 dB
PWR	17-600mW			PWR	6.7mw +	THD (%)	0.0004-0.04	Inputs	Analog/Dig.
Packages: 5.3 - 144mm ²		Packages: 2 - 517mm ²		Packages: 7.8 - 170mm ²		Packages: 6.4 - 144mm ²		Packages: 7.5 - 76mm ²	
1K: \$0.80 - \$8.55		1K: \$0.26 - \$10.75		1K: \$1.23 - \$19.25		1K: \$0.89 - \$11.18		1K: \$1.39 - \$3.75	

Audio Codec Features

- **Low power without sacrificing performance**
 - Less than 10mW power – up to 102dB SNR
 - PowerTune™ – Power vs. SNR
- **Optional Amplifier integration**
 - Class D, Headphone (DirectPath™)
- **Wide range of inputs/outputs**
 - Up to 10 inputs / 7 outputs (AIC3106)
- **Integrated Signal Processing**
 - EQ, Bass Boost, Treble, Algorithm
- **Various Control and Audio I/F options**
 - I2C, SPI, H/W, DSP, L, R, I2S, etc
- **Multiple packaging options**
 - as small as 7.8mm²
 - Multiple pin to pin options
 - TQFP, CSP, BGA, TSSOP

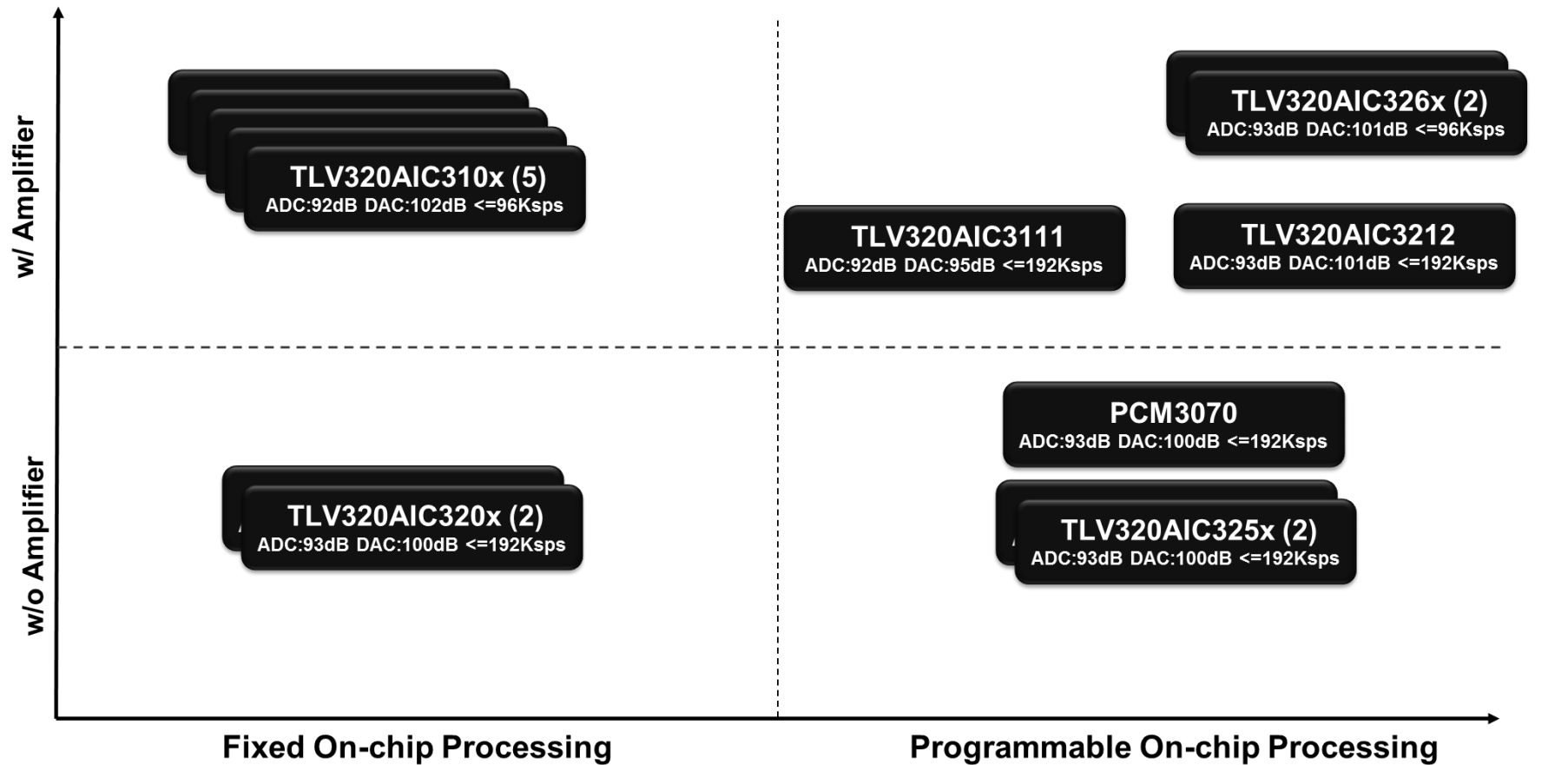


EXISTING

NEW



ROADMAP

Audio Codecs



Additional CODEC solutions are available. These are our most popular!

TLV320AIC320x Series

	LDO	THD (ADC/DAC)	SNR (ADC/DAC)	Inputs / Outputs	DirectPath™	Package	Pin Compatibility
AIC3206 		-84 / -81	93 / 100	6 / 6	Ground Centered Output	BGA : 3.5x3.2 QFN : 5x5mm	AIC3256 w/DSP
AIC3204 	1.8V to 3.6V	-85 / -83				QFN : 5x5mm	AIC3254 w/DSP

TLV320AIC320x

1.8V Low Power Stereo Codecs

Features

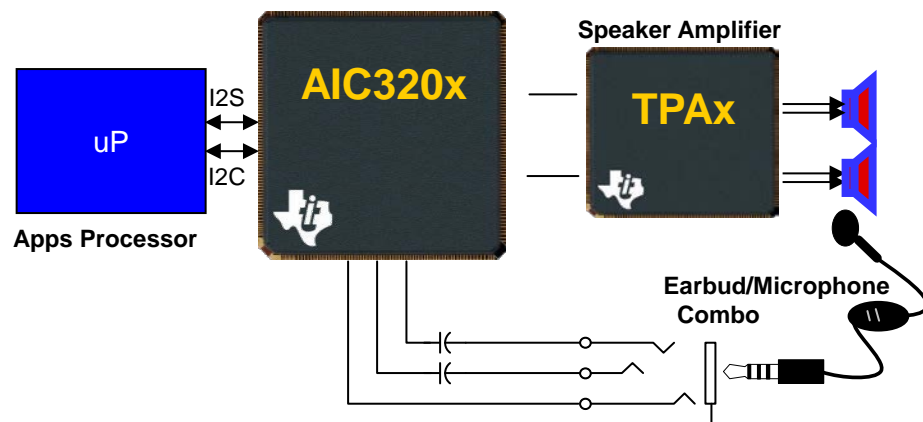
- Stereo 8-192ksps audio DAC up to 100dB SNR
- Stereo 8-192ksps audio ADC up to 93dB SNR
- PowerTune™ adjustable Power vs. SNR
- DirectPath™ Headphone AMP (3206 only)
- Integrated LDOs (3204 only)
- Extensive record/playback processing blocks
- Integrated PLL

Benefits

- User controls power vs. SNR tradeoff
- Eliminates DC-Blocking Caps (3206 only)
- Allow single-supply operation (1.9V – 3.6V)
- Flexible audio clock generation (512KHz to 50MHz input clock)

Applications

Cell Phones
Portable navigation Devices (PND)
Headsets



TLV320AIC320x Block Diagram

1.8V Low Power Stereo Codecs

3204/03 Only

3206 Only

Bypass mode

PowerTune™

100dB SNR

93dB SNR

18 processing blocks
for audio effects

DirectPath
(capless)
stereo
headphones

25 processing blocks
for audio effects

6 SE/3 Diff audio
inputs with mixing
and level control

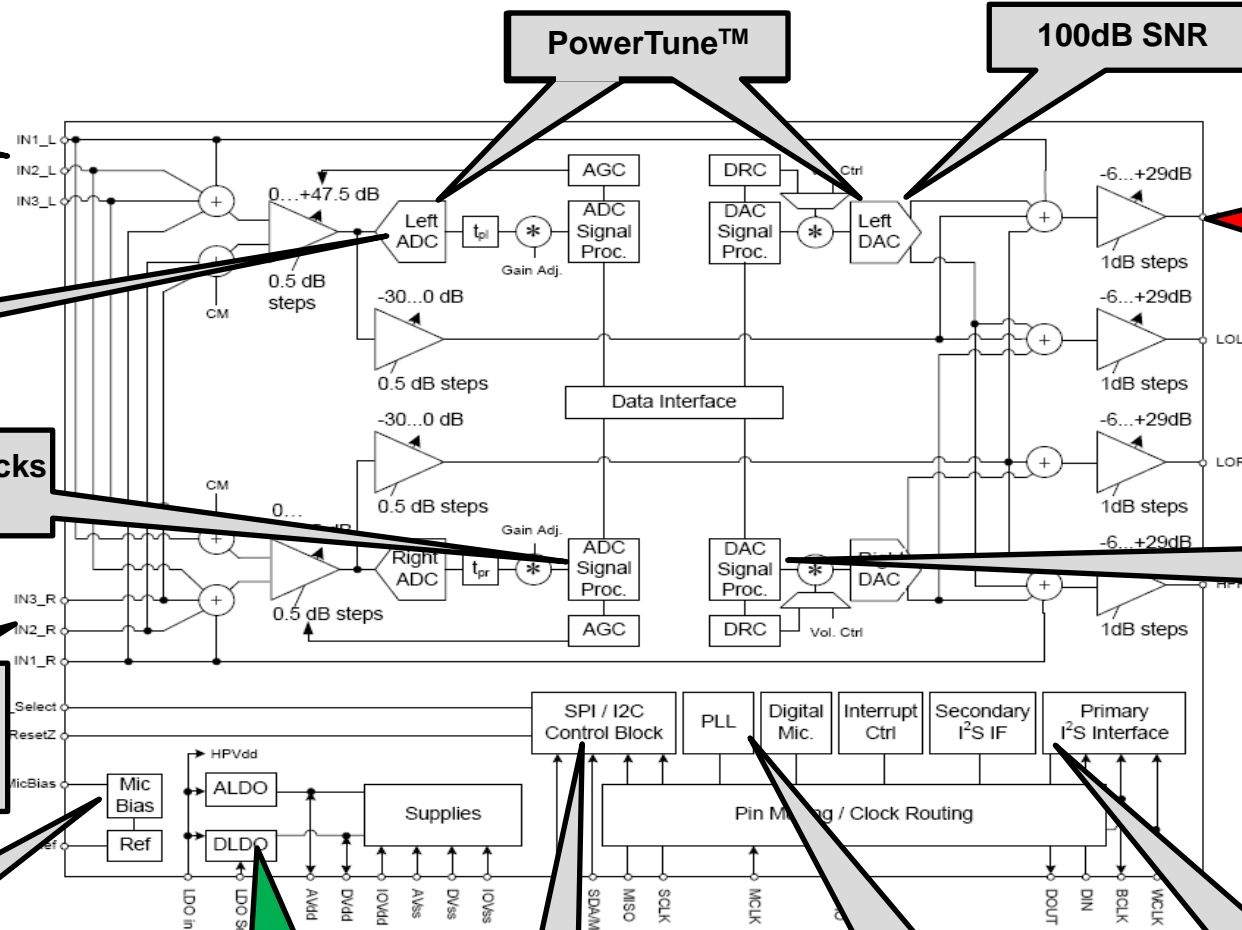
Microphone input
w/ bias, preamp,
AGC

Integrated LDO –
Single-supply
operation

I2C or SPI
Control I/F




Integrated PLL
512KHz to 50MHz

I2S, L, R, DSP
and TDM I/F



TEXAS INSTRUMENTS

TLV320AIC325x Series

	LDO	THD (ADC/DAC)	SNR (ADC/DAC)	Inputs / Outputs	DirectPath	Package	Pin Compatibility
AIC3256 		-84 / -81	93 / 100	6 / 4	Ground Centered Output	BGA : 3.5x3.25 QFN : 5x5mm	AIC3206 w/o DSP
AIC3254 	1.8V to 3.6V	-85 / -83		6 / 4		QFN : 5x5mm	AIC3204 w/o DSP
AIC3253 	1.8V to 3.6V	No ADC / -80	- / 100	4 (PDM) / 2		CSP : 2.7x2.7mm QFN : 4x4mm	

TLV320AIC325x

Low Power Stereo Codecs w/ MiniDSP

Features

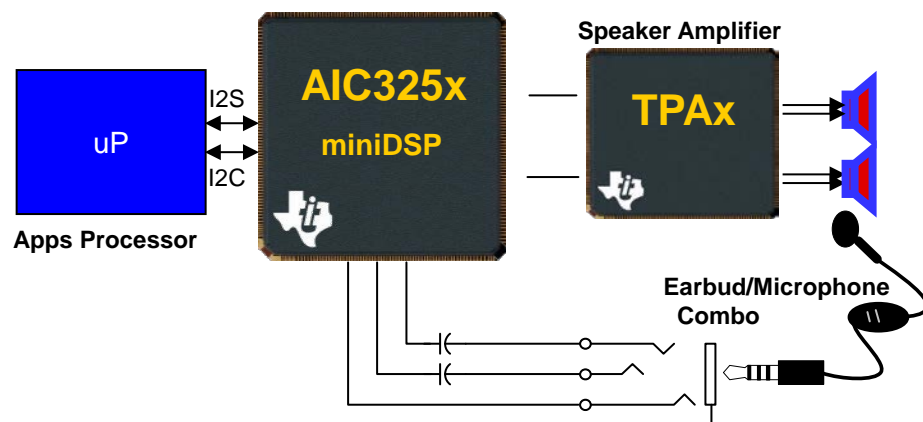
- Stereo 8-192ksps audio DAC up to 100dB SNR
- Stereo 8-192ksps audio ADC up to 93dB SNR
 - ADC not included in AIC3253
- PowerTune™ adjustable Power vs. SNR
- DirectPath™ Headphone AMP (3206 only)
- Integrated LDOs (3204 only)
- Integrated PLL
- Integrated DSPs

Benefits

- User controls power vs. SNR tradeoff
- Eliminates DC-Blocking Caps
- Allow single-supply operation (1.9V – 3.6V)
- Flexible audio clock generation (512KHz to 50MHz input clock)
- Offload host processor

Applications

Cell Phones
Portable navigation Devices (PND)
Headsets



TEXAS INSTRUMENTS

Low Power Stereo Codecs w/ MiniDSP

3254/53 Only



TLV320AIC325x Series

Low Power Stereo Codecs w/ MiniDSP

3256 Only

3254/53 Only

PowerTune™

100dB SNR

Bypass mode

93dB SNR
(No ADCs
on 3253)

MiniDSPs

6 SE/3 Diff audio
inputs with mixing
and level control

Microphone input
w/ bias, preamp,
AGC

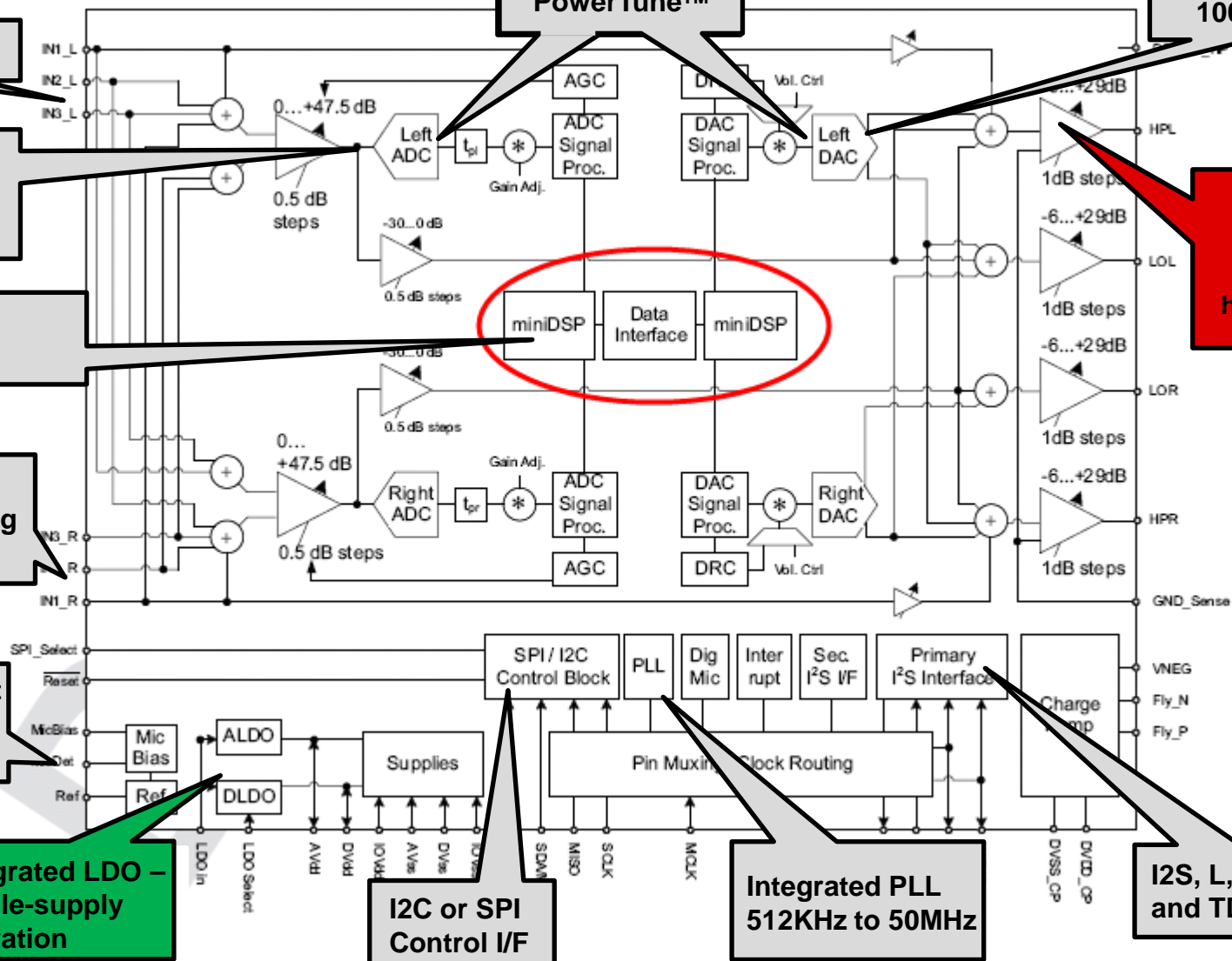
Integrated LDO –
Single-supply
operation

I2C or SPI
Control I/F

Integrated PLL
512KHz to 50MHz

I2S, L, R, DSP
and TDM I/F

DirectPath
(capless)
stereo
headphones



TEXAS INSTRUMENTS

TLV320AIC310x Series

	Amplifier	THD (ADC/DAC)	SNR (ADC/DAC)	Inputs / Outputs	Control I/F	Package	
AIC3107 	Class-D	-88 / -84	92 / 97	7 / 6	I2C	CSP : 3.5x3mm QFN : 5x5mm	
AIC3106 	Class-AB	-88 / -94	92 / 102	10 / 7	I2C , SPI	BGA : 5x5mm QFN : 7x7mm	
AIC3105 	Class-AB	-89 / -95	92 / 102	6 / 6	I2C	QFN : 5x5mm	
AIC3104 	Class-AB	-89 / -84	92 / 102	6 / 6	I2C	QFN : 5x5mm	Pin Compatible
AIC3101 	Class-AB	-89 / -95	92 / 102	6 / 6	I2C	QFN : 5x5mm	

TLV320AIC310x

Low Power Stereo Codecs

Features

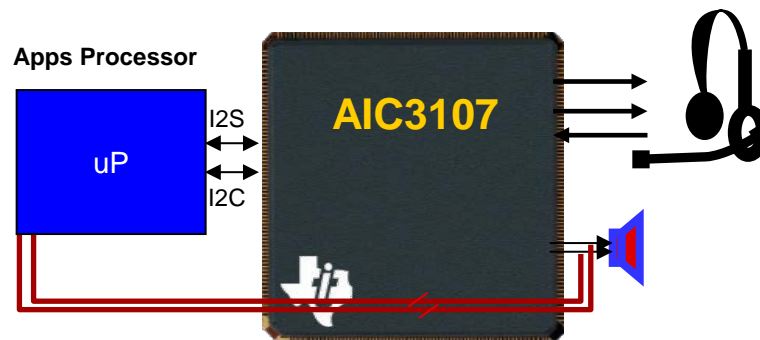
- Stereo 8-96ksps audio DAC up to 102dB SNR
- Stereo 8-96ksps audio ADC up to 92dB SNR
- Integrated Amplifier
 - AIC3107 (Class D)
 - AIC3101-6(Class AB)
- Built-in Headphone Detect (3106/3107)
- Integrated PLL
- Programmable Input/Output Gains

Benefits

- No external Amp required - Single chip solution
- Flexible audio clock generation (512KHz to 50MHz input clock)
- Longer AGC time constraints

Applications

Cell Phones
Portable navigation Devices (PND)
Headsets
Voice/audio processors
Conference / IP Phones
General Portable Audio Equipment



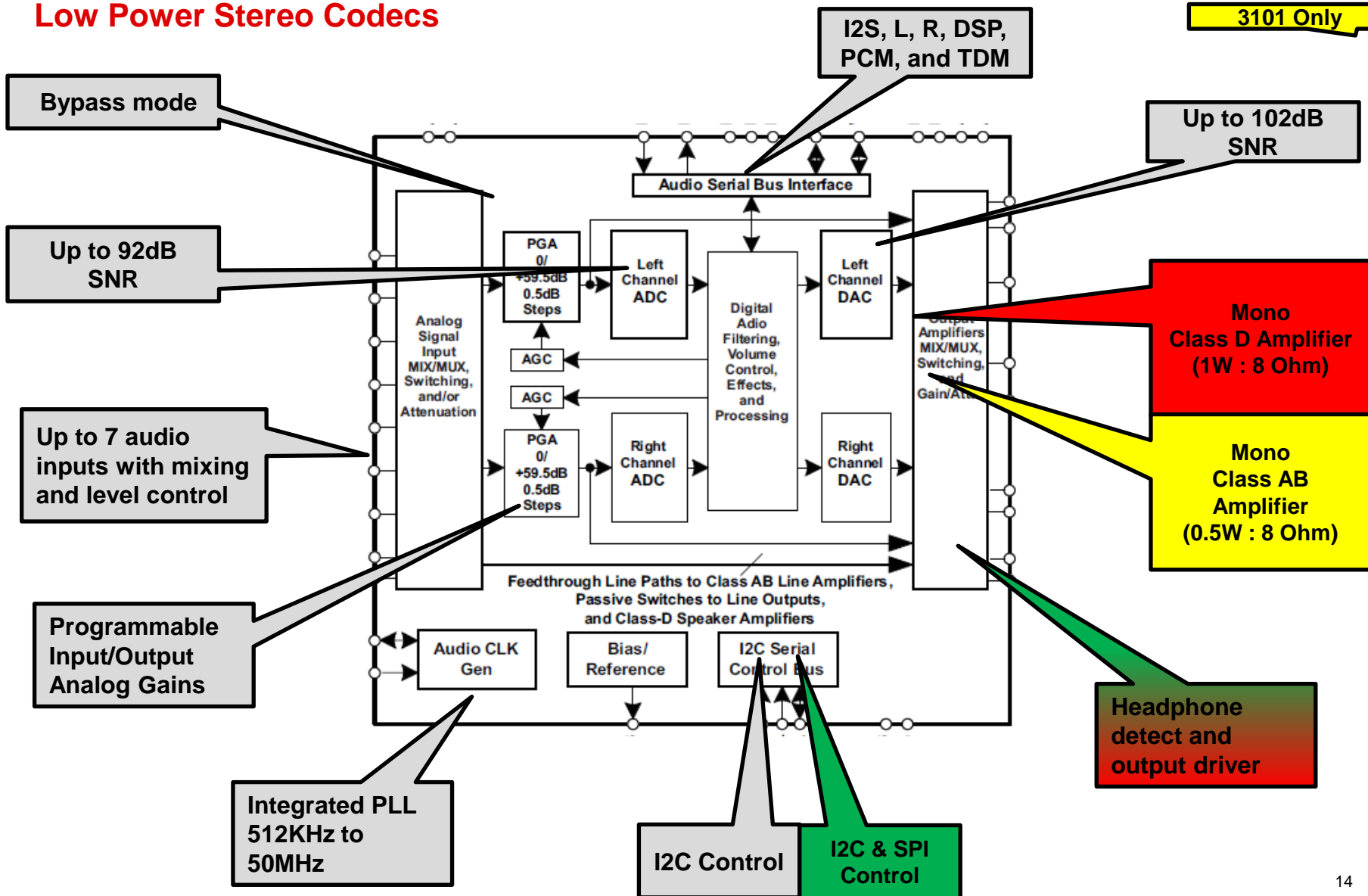
TLV320AIC310x Series

Low Power Stereo Codecs

3106 Only




3107 Only

3101 Only



TLV320AIC326x Series

Low Power Stereo Codecs w/ Amplifier and miniDSP

	Amplifier	THD (ADC/DAC)	SNR (ADC/DAC)	Inputs / Outputs	DirectPath	Package
 AIC3268 TEXAS INSTRUMENTS	Class-D	-88/ -91	95 / 105	8 / 7	Ground Centered Output	QFN : 9x9mm
 AIC3263 TEXAS INSTRUMENTS		-88 / -92	93 / 101	8 / 7		BGA : 5x5mm
 AIC3262 TEXAS INSTRUMENTS		-87 / -88				BGA : 5x5mm

TLV320AIC326x

Low Power Stereo Codecs w/ Amplifier/On-chip Processing

Features

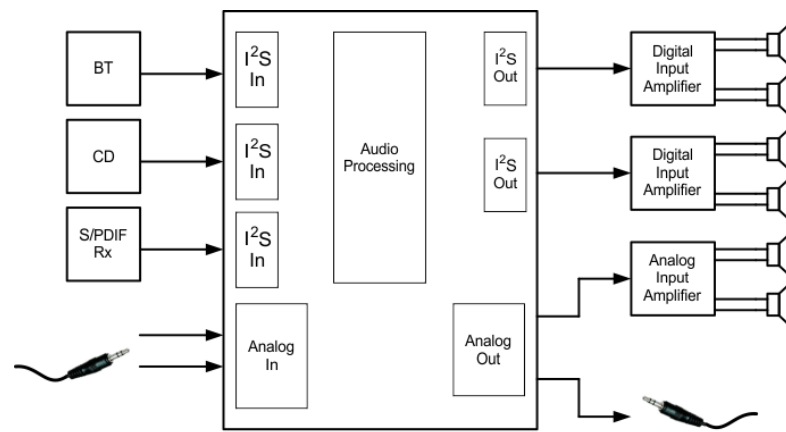
- Stereo 8-192ksps audio DAC up to 105dB SNR
- Stereo 8-192ksps audio ADC up to 95dB SNR
- Integrated Stereo Class-D Amplifier
- PowerTune™ adjustable Power vs. SNR
- DirectPath™ Headphone Driver
- Fully Programmable Integrated DSPs
- 12-bit Secondary ADC w/ Temp Sensor
- Integrated PLL

Benefits

- No external Amp required - Single chip solution
- User controls power vs. SNR tradeoff
- Eliminates DC-Blocking Caps
- Extensive Signal Processing Options
- Voltage measurements for suspend settings
- Flexible audio clock generation (512KHz to 50MHz input clock)

Applications

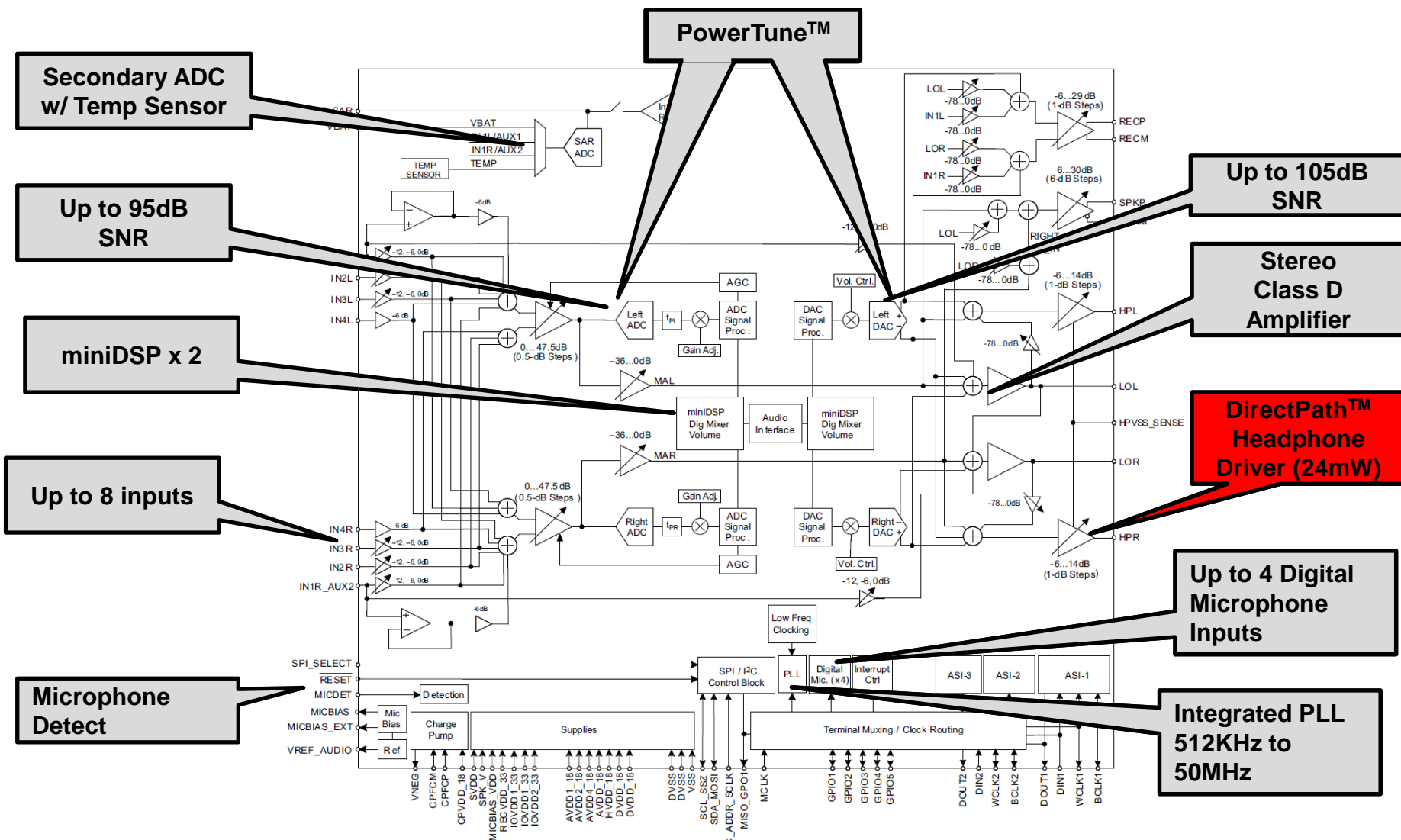
Cell Phones
Portable navigation Devices (PND)
Headsets
Voice/audio processors
Conference / IP Phones
General Portable Audio Equipment



TLV320AIC326x Series

Low Power Stereo Codecs w/ Amplifier/miniDSP

3268Only



TLV320AIC3212

Low Power Stereo Codec w/ Amplifier / HP Driver

Features

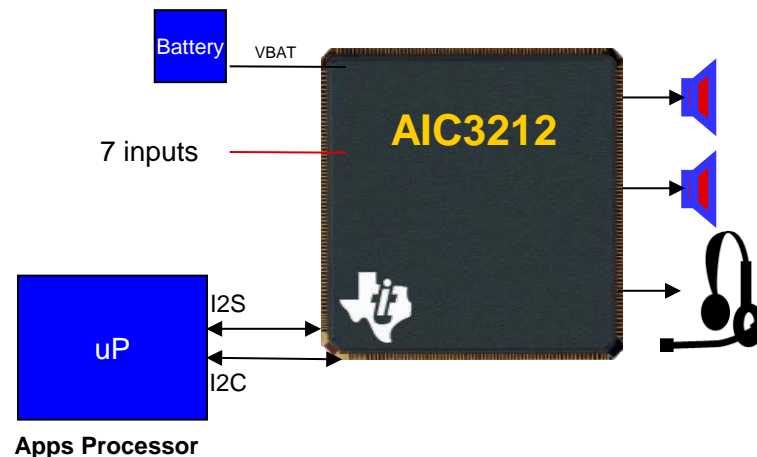
- Stereo 8-192ksps audio DAC up to 101dB SNR
- Stereo 8-192ksps audio ADC up to 93dB SNR
- Integrated Stereo Class-D Amplifier
- PowerTune™ adjustable Power vs. SNR
- DirectPath™ Headphone Driver
- Selectable audio-processing blocks
- 12-bit Secondary ADC w/ Temp Sensor
- Integrated PLL
- Small 4.81x4.81, 81-ball WCSP (YZF)

Benefits

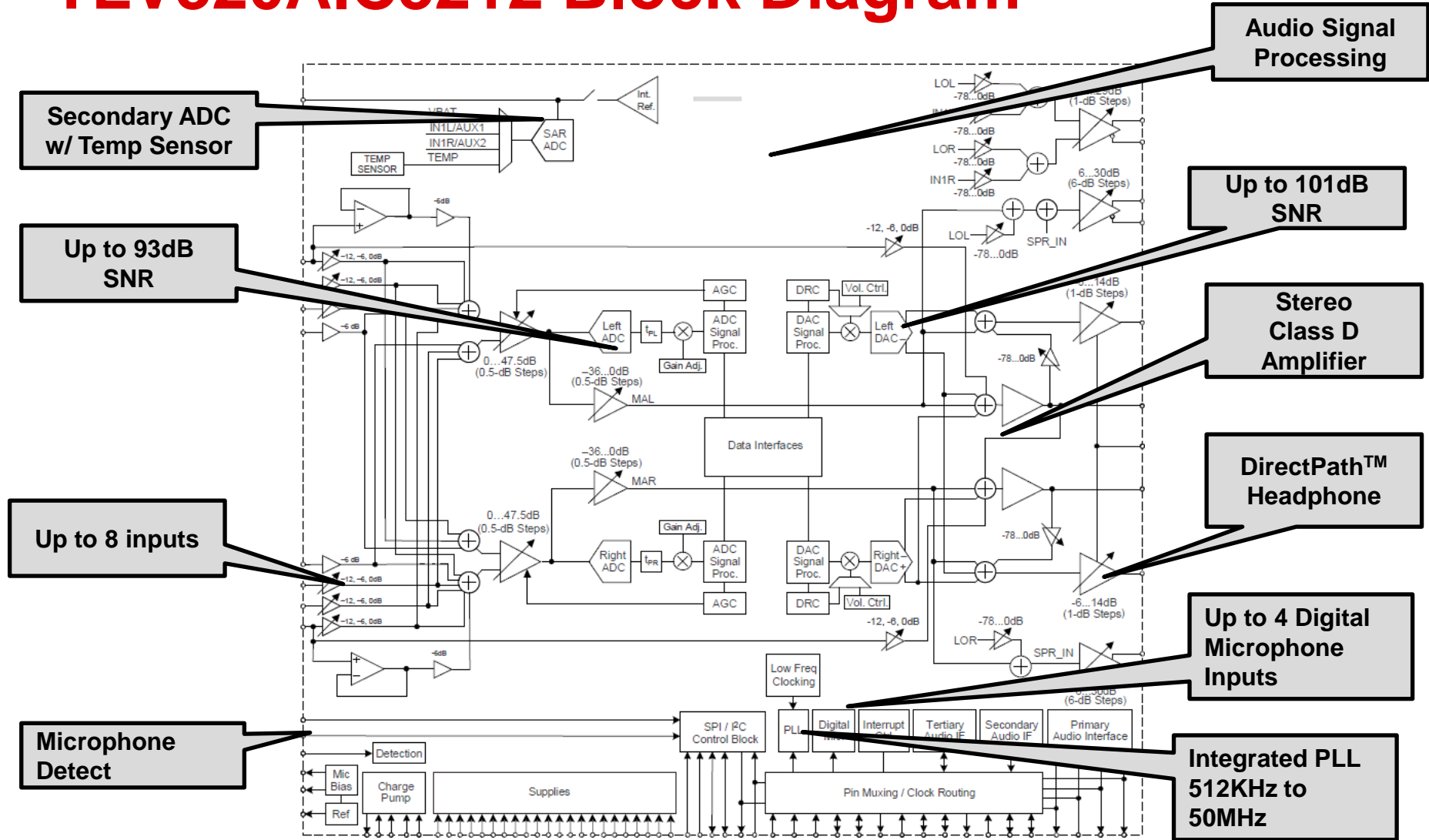
- No external Amp required - Single chip solution
- User controls power vs. SNR tradeoff
- Eliminates DC-Blocking Caps
- Noise removal of mechanical coupling
- Voltage measurements for suspend settings
- Flexible audio clock generation (512KHz to 50MHz input clock)
- Perfect for low power and small form factor designs

Applications

Cell Phones
Portable Computing
Tablets / E-Books
Headsets
Portable navigation Devices (PND)



TLV320AIC3212 Block Diagram



TLV320AIC3111

Low Power / High Performance Audio Codec w/ MiniDSP and Class-D Amplifier

Features

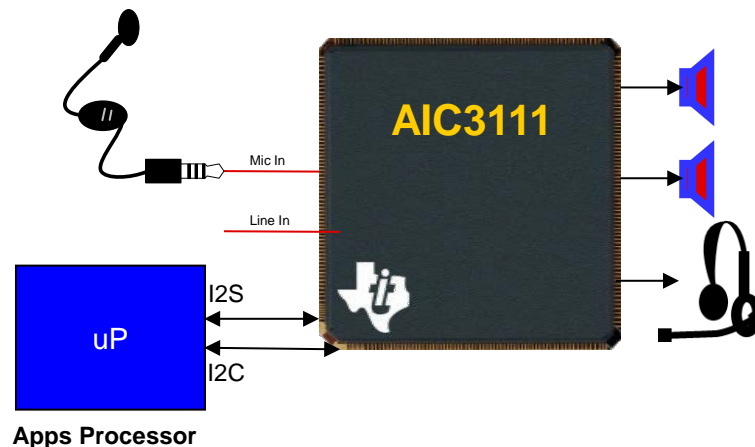
- Stereo 8-192ksps audio DAC up to 95dB SNR
- Mono 8-192ksps audio ADC up to 93dB SNR
- Integrated Stereo Class-D Amplifier
- MiniDSP
- Selectable audio-processing blocks
- Integrated PLL
- Small 5x5mm, 32-pin QFN (RHB)

Benefits

- No external Amp required - Single chip solution
- Advanced Audio Algorithms including SRS WOW
- Bass Boost/Treble/EQ
- Voltage measurements for suspend settings
- Flexible audio clock generation (512KHz to 50MHz input clock)
- Perfect for low power and small form factor designs

Applications

Cell Phones
Portable Computing
Tablets / E-Books
Headsets
Portable navigation Devices (PND)



PCM3070

High Performance Audio Codec w/ Programmable On-Chip Processing

Features

- Stereo 8-192ksps audio DAC up to 100dB SNR
- Stereo 8-192ksps audio ADC up to 93dB SNR
- Programmable On-Chip Processing
- Selectable audio-processing blocks
- Integrated PLL
- Up to six analog inputs, SE or Differential
- Core of TI's Value SoundBar reference design kit

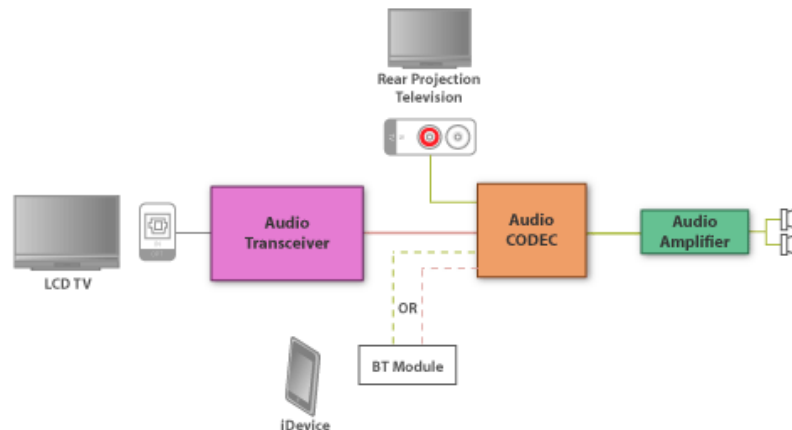
Benefits

- Advanced Audio Algorithms including SRS WOW Bass Boost/Treble/EQ
- Voltage measurements for suspend settings
- Flexible audio clock generation (512KHz to 50MHz input clock)
- Flexible inputs for analog, SPDIF, or USB
- Ready for production, 30% lower cost when compared to discrete solutions

Applications

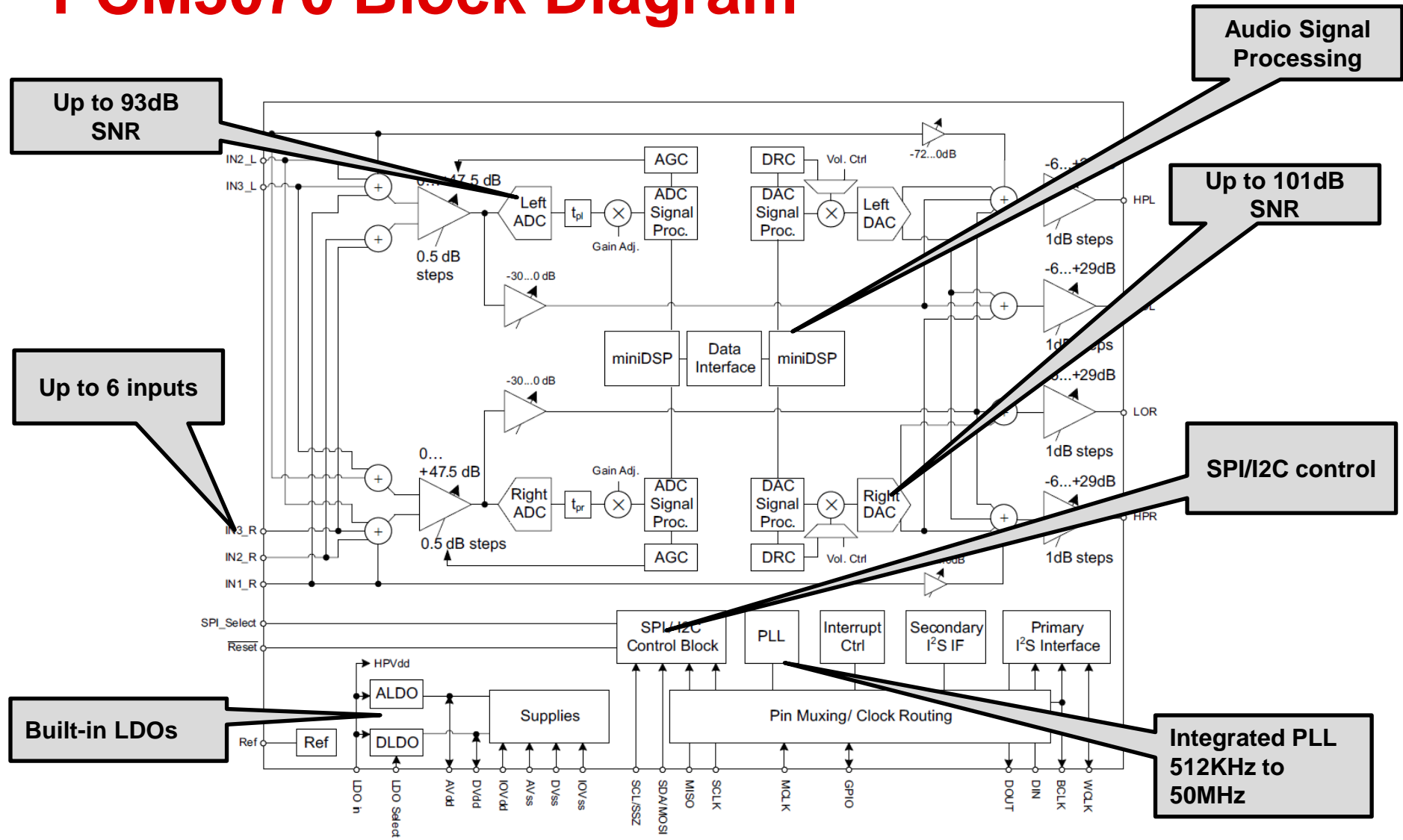
Soundbars
Docking Stations
TVs
2.0/2.1 Home Audio Systems

Analog Version



TEXAS INSTRUMENTS

PCM3070 Block Diagram



R-E-D TODAY!

Research



www.ti.com/audio - Learn about all our audio products

Parametric Search - Intuitive comparison tool

Audio Selection Tool - Let us help narrow your options

Technical Documents - Datasheets, package info, etc

Evaluate



EVM & Development Kits - **Low cost, easy to use**

PurePath Software - **No Hassle, free software**

Training videos - **24/7, anytime, anywhere**

End Equipment Block Diagrams - **TI Companion devices**

Design



Audio Reference Designs -schematics, gerbers, etc.

Free Samples - Try before you buy (qty limits)

Models & Tools - IBIS, symbols, calculators and more

E2E Forum - Get support from TI experts & community

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Applications Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Automotive and Transportation	www.ti.com/automotive
Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Video and Imaging	www.ti.com/video

TI E2E Community

e2e.ti.com